

C5D10170H

Silicon Carbide Schottky Diode

Z-REC[®] RECTIFIER

V_{RRM}	=	1700 V
$I_F(T_c=135^{\circ}\text{C})$	=	16 A
Q_c	=	111 nC

Features

- 1.7kV Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F

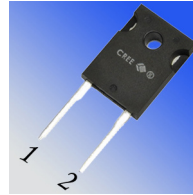
Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies (SMPS)
- Boost diodes in PFC or DC/DC stages
- Free Wheeling Diodes in Inverter stages
- 1500V Solar Inverter

Package



TO-247-2



Part Number	Package	Marking
C5D10170H	TO-247-2	C5D10170

Maximum Ratings ($T_c=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	1700	V		
V_R	DC Peak Reverse Voltage	1700	V		
I_F	Continuous Forward Current	33 16 10	A	$T_c=25^{\circ}\text{C}$ $T_c=135^{\circ}\text{C}$ $T_c=150^{\circ}\text{C}$	Fig. 3
I_{FRM}	Repetitive Peak Forward Surge Current	45 26	A	$T_c=25^{\circ}\text{C}$, $t_p=10$ ms, Half Sine Pulse $T_c=110^{\circ}\text{C}$, $t_p=10$ ms, Half Sine Pulse	
I_{FSM}	Non-Repetitive Forward Surge Current	55 41	A	$T_c=25^{\circ}\text{C}$, $t_p=10$ ms, Half Sine Pulse $T_c=110^{\circ}\text{C}$, $t_p=10$ ms, Half Sine Pulse	
P_{tot}	Power Dissipation	185 80	W	$T_c=25^{\circ}\text{C}$ $T_c=110^{\circ}\text{C}$	Fig. 4
T_J, T_{stg}	Operating Junction and Storage Temperature	-55 to +175	$^{\circ}\text{C}$		
	TO-247 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.5 2.2	1.8 2.5	V	$I_F = 10\text{ A}$ $T_J = 25^\circ\text{C}$ $I_F = 10\text{ A}$ $T_J = 175^\circ\text{C}$	Fig. 1
I_R	Reverse Current	20 120	200 300	μA	$V_R = 1700\text{ V}$ $T_J = 25^\circ\text{C}$ $V_R = 1700\text{ V}$ $T_J = 175^\circ\text{C}$	Fig. 2
Q_C	Total Capacitive Charge	111		nC	$V_R = 1700\text{ V}$, $I_F = 10\text{ A}$ $di/dt = 200\text{ A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$	Fig. 5
C	Total Capacitance	830 51 50		pF	$V_R = 0\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 800\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 1700\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$	Fig. 6
E_C	Capacitance Stored Energy	76		μJ	$V_R = 1700\text{ V}$	Fig. 7

Note: This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.81	$^\circ\text{C}/\text{W}$	Fig. 8

Typical Performance

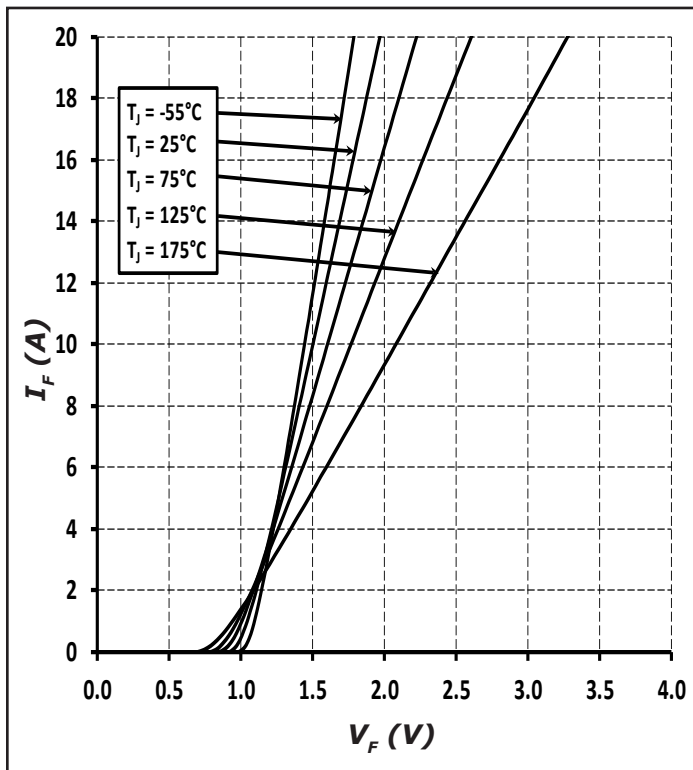


Figure 1. Forward Characteristics

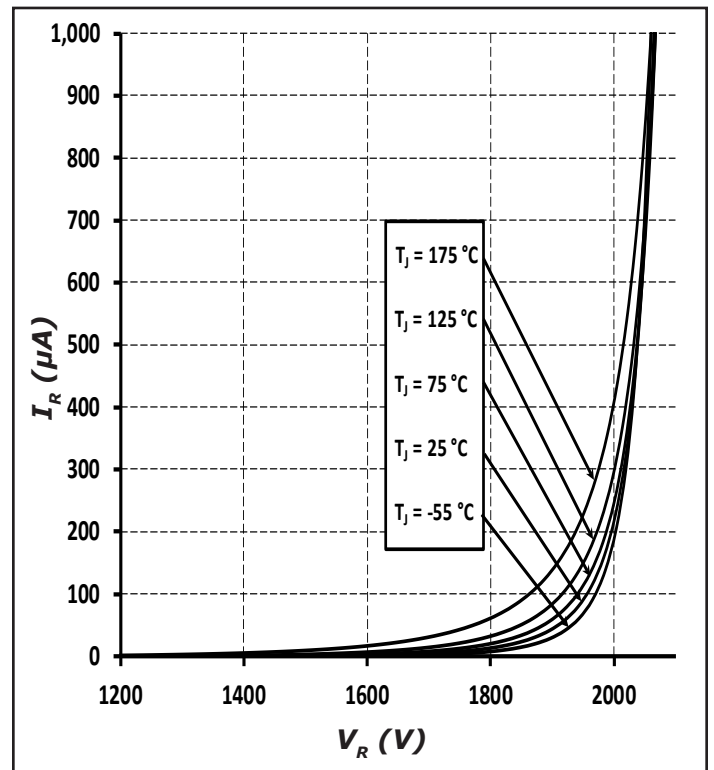


Figure 2. Reverse Characteristics

Typical Performance

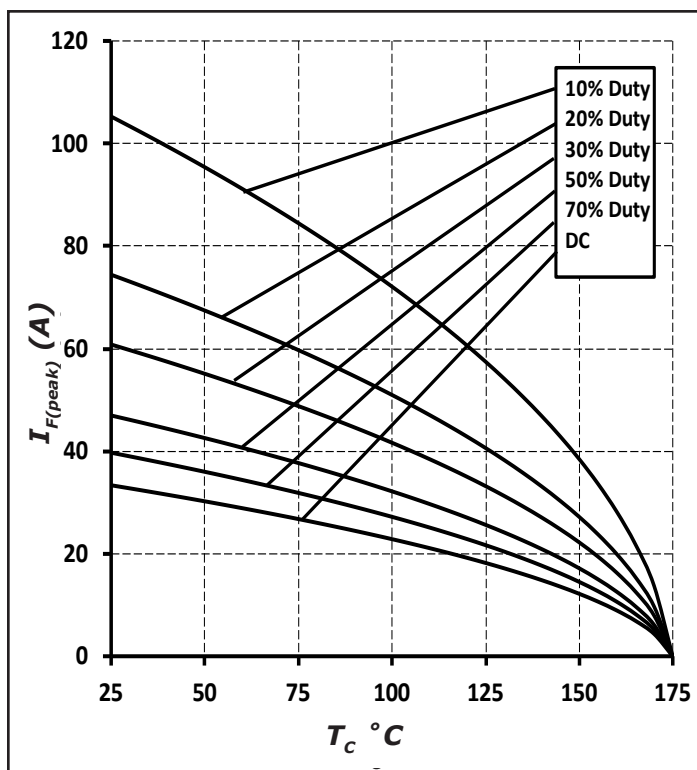


Figure 3. Current Derating

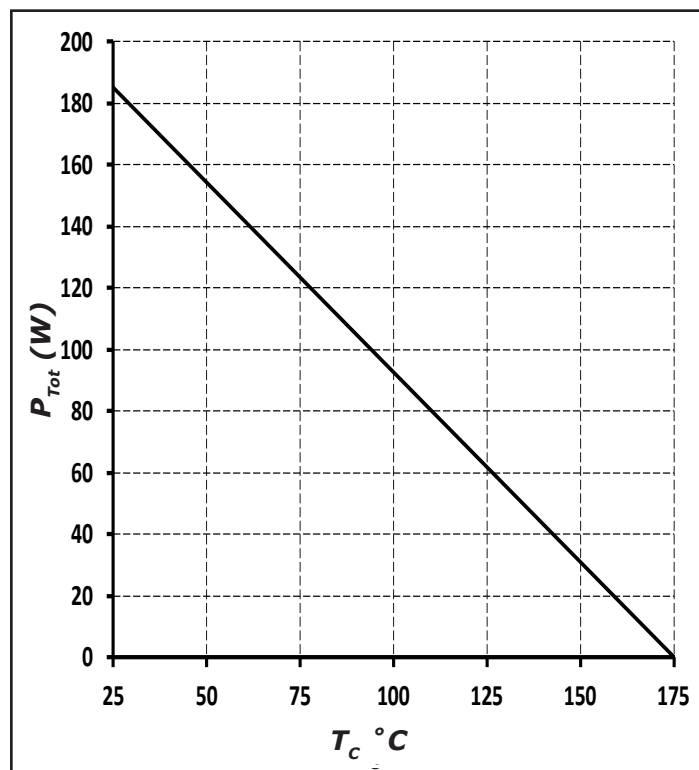


Figure 4. Power Derating

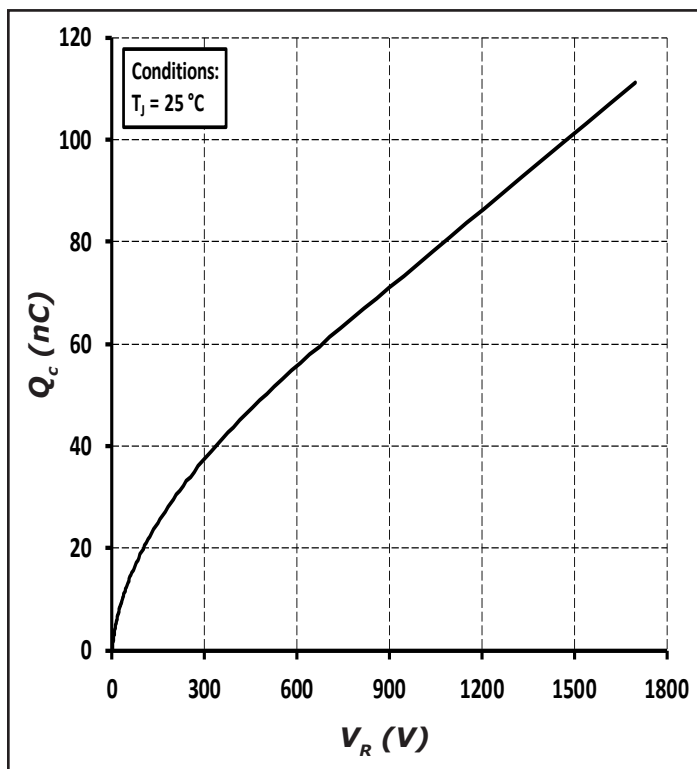


Figure 5. Recovery Charge vs. Reverse Voltage

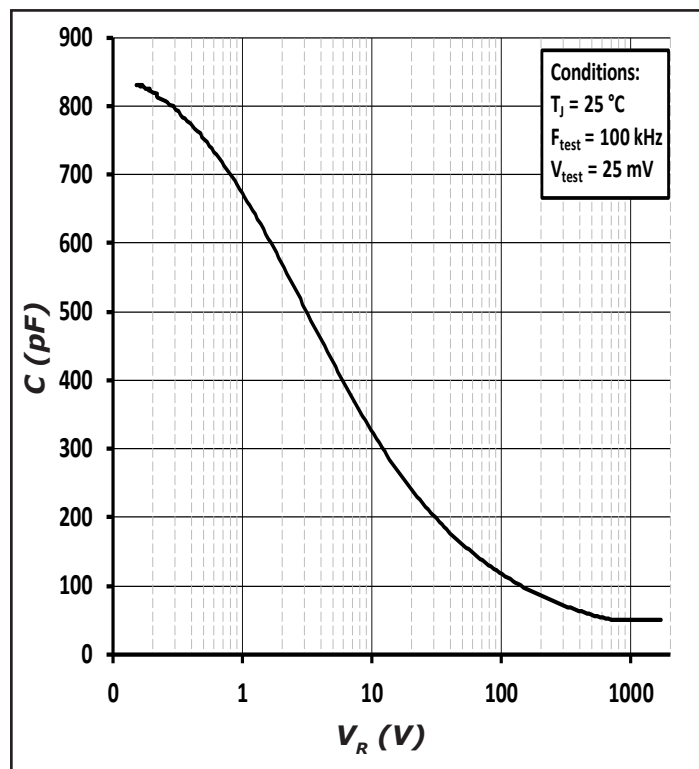


Figure 6. Capacitance vs. Reverse Voltage

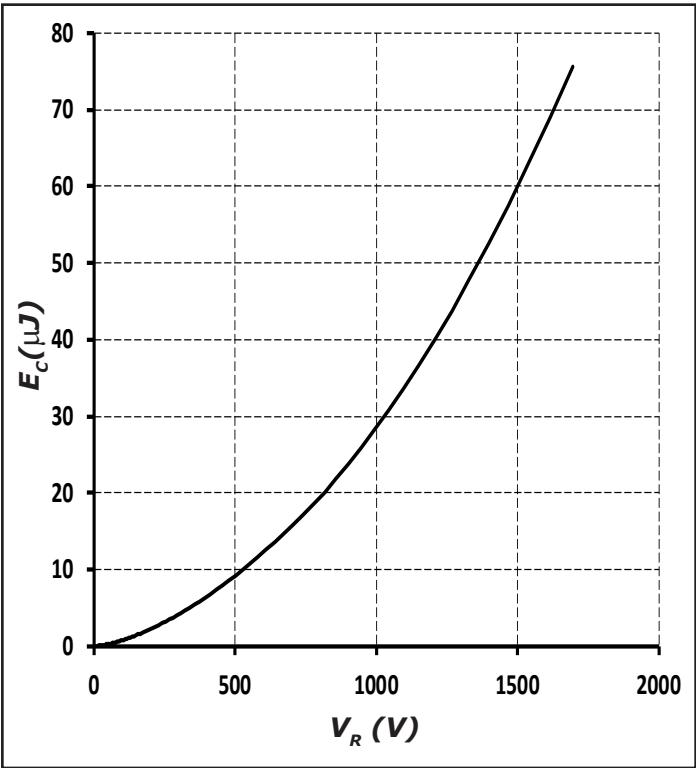


Figure 7. Typical Capacitance Stored Energy

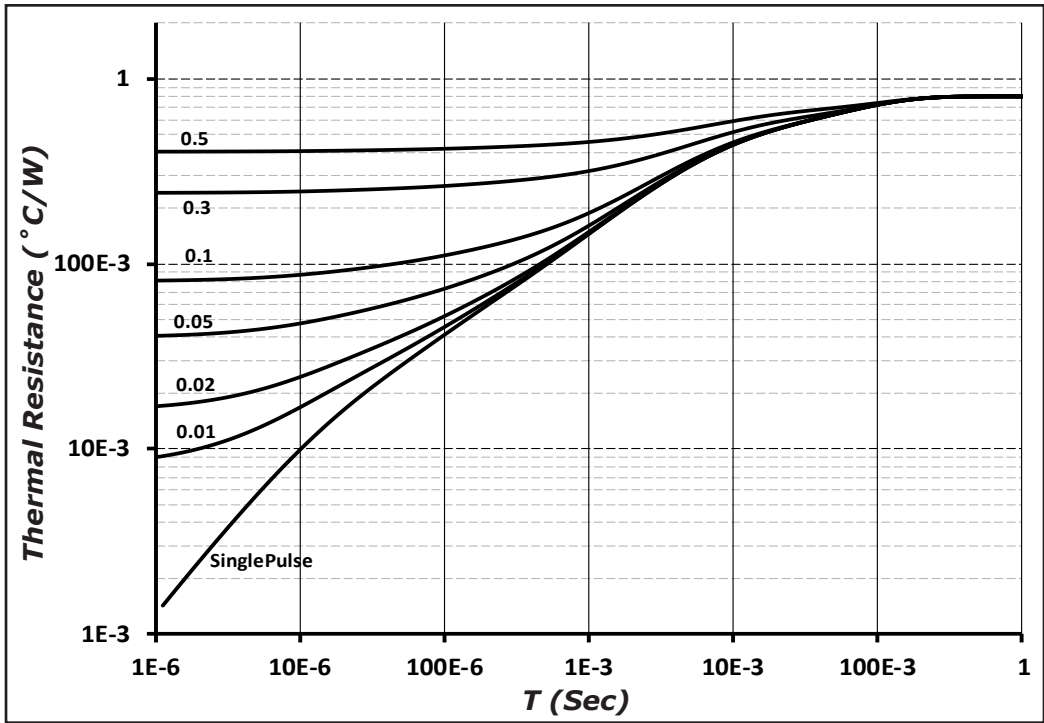
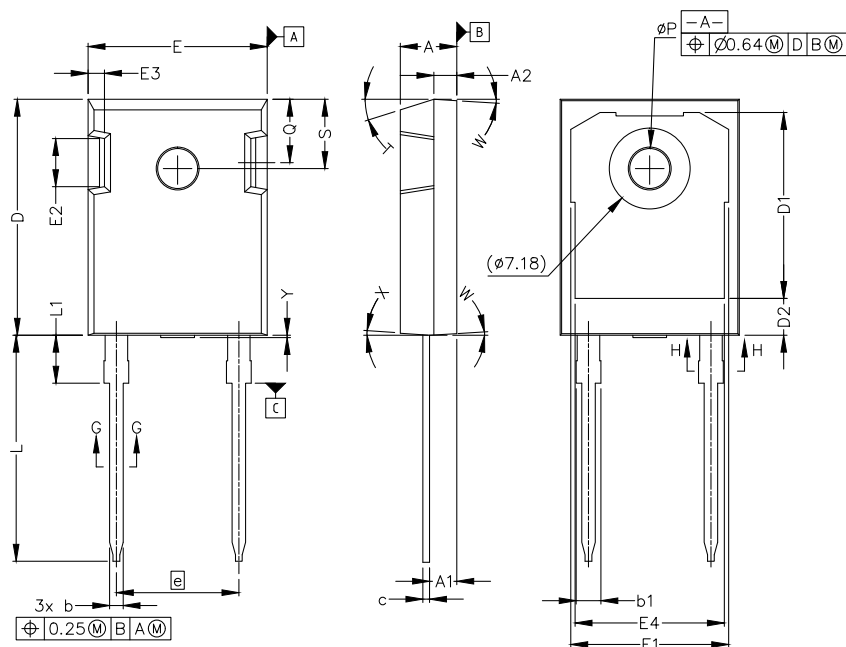


Figure 8. Transient Thermal Impedance

Package Dimensions

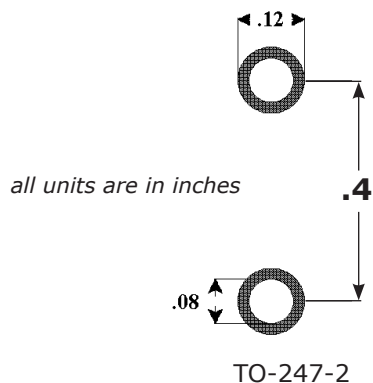
Package TO-247-2



POS	Inches		Millimeters	
	Min	Max	Min	Max
A	0.190	0.205	4.70	5.31
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
b	0.039	0.055	0.99	1.40
b1	0.065	0.095	1.65	2.41
c	0.015	0.035	0.38	0.89
D	0.819	0.845	20.80	21.46
D1	0.640	0.683	16.25	17.35
D2	0.112	0.124	2.86	3.16
E	0.620	0.640	15.49	16.26
E1	0.516	0.557	13.10	14.15
E2	0.135	0.201	3.43	5.10
E3	0.039	0.075	1.00	1.90
E4	0.487	0.529	12.38	13.43
e	0.428 BSC		10.88 BSC	
L	0.78	0.80	19.81	20.32
L1	-	0.177	-	4.50
ØP	0.138	0.144	3.51	3.66
Q	0.212	0.244	5.38	6.20
S	0.238	0.248	6.04	6.3
T	17.5° REF.			
W	3.5° REF.			
X	4° REF.			
Y	0	0.5	0	0.02



Recommended Solder Pad Layout

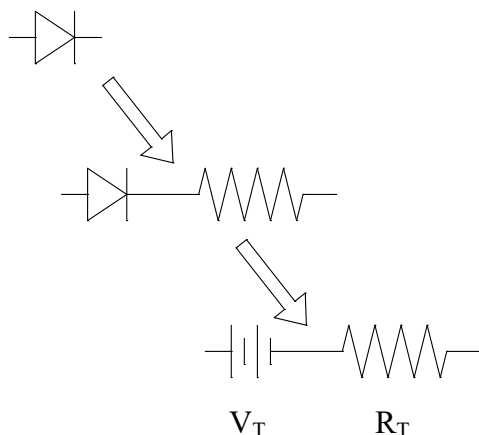


Part Number	Package	Marking
C5D10170H	TO-247-2	C5D10170

Note: Recommended soldering profiles can be found in the applications note here:
http://www.wolfspeed.com/power_app_notes/soldering



Diode Model



$$V_{fT} = V_T + I_f \cdot R_T$$

$$V_T = 0.94 + (T_J \cdot -1.0 \cdot 10^{-3})$$

$$R_T = 0.027 + (T_J \cdot 2.8 \cdot 10^{-4})$$

Note: T_J = Diode Junction Temperature In Degrees Celsius,
valid from 25°C to 175°C

Notes

- RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Ecology section of our website at <http://www.wolfspeed.com/power/tools-and-support/product-ecology>.

- REACH Compliance**

REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

- This product has not been designed or tested for use in, and is not intended for use in, applications implanted into the human body nor in applications in which failure of the product could lead to death, personal injury or property damage, including but not limited to equipment used in the operation of nuclear facilities, life-support machines, cardiac defibrillators or similar emergency medical equipment, aircraft navigation or communication or control systems, or air traffic control systems.

Related Links

- Cree SiC Schottky diode portfolio: <http://www.wolfspeed.com/Power/Products#SiCSchottkyDiodes>
- Schottky diode Spice models: <http://www.wolfspeed.com/power/tools-and-support/DIODE-model-request2>
- SiC MOSFET and diode reference designs: <http://go.pardot.com/l/101562/2015-07-31/349i>